

## School of Architecture + Design (A+D) Study Abroad in Hong Kong

Off-campus Spring Break  
(Saturday March 3 – Saturday March 10, 2018)

### Scholarship Application Form



Dear Students and Parents:

**Introduction:** The School of Architecture + Design (A+D) makes every effort to award financial aid when circumstances require it. A+D is generously providing funding in the amount of \$3,000 to support three (3) scholarships in the amount of \$1,000 each for students interested in attending the 2018 Off-campus Spring Break Travel Program to Hong Kong. The scholarships are need and merit based. Students and parents are strongly encouraged to also check with A+D, Virginia Tech Financial Aid Office, and other local and federal agencies for financial aid and scholarships options in addition to those provided by this application form. Each student interested to be considered for this scholarship should complete the below application form.

**Application deadline:** Friday, October 6, 2017 (this form in .pdf **electronically** to Henri T. de Hahn: [hdehahn@vt.edu](mailto:hdehahn@vt.edu))

**Announcement deadline:** no later than Friday, October 20, 2017 (electronically by Henri T. de Hahn to each of the recipients)

**Process:** Upon receipt of the electronic application form, the faculty of record (Henri T. de Hahn) will submit it to Prof. Kathryn Albright, Associate Dean for Academic Affairs, with the request to obtain financial information applicable to each student's application. This will be done through Virginia Tech's Office of Scholarships and Financial Aid Office. The Associate Dean Albright will keep this financial information confidential and will make an assessment of each student's need and rank him or her accordingly. A meeting between Associate Dean Albright and Prof. de Hahn will take place to discuss her recommendations.

All three awardees will receive notification by **Friday, October 20, 2017**

**Additional questions:** Please contact Henri T. de Hahn ([hdehahn@vt.edu](mailto:hdehahn@vt.edu))

1 . Student Information:			
Last Name	First Name	Middle Name	<e-mail address> @vt.edu
Campus/Local Address	Local Tel. No.	College/Major/Year	Current Prof.

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<b>Birth Date</b>	<b>Place of Birth</b>	<b>Student ID Number</b>	<b>Status</b>
			Undergrad – Grad – VA – Non-VA
<b>Citizenship/Immigration Status</b>	<b>Passport Nr.</b>	<b>Place of Issue</b>	<b>Date of Issue</b>

**2. Parent/Guardian Information:**

<b>Parent's/Guardian's Name 1</b>	<b>Address</b>	<b>City/State/Zip</b>	<b>Phone Numbers</b>
<b>Parent's/Guardian's email:</b>			
<b>Parent's/Guardian's Name 2</b>	<b>Address</b>	<b>City/State/Zip</b>	<b>Phone Numbers</b>

**3. Program and Financial Request Information**

<b>Current A+D GPA:</b>	
<b>Program Name:</b> 2017 Off-campus Spring Break to Hong Kong	
<b>Listed Program Fee:</b>	+ \$3,600
<b>Estimated transportation Fee:</b>	+
<b>Expected family Contribution:</b>	-
<b>Other Scholarship Contributions:</b>	-
<b>Total Amount requested:</b>	+ \$1,000

**4. Student section to complete: statement of purpose – Please attach additional pages if needed**

What are the reasons for requesting these funds? Please note any extenuating financial circumstances (medical, job loss, unusual expenses, etc.) or significant family expenses, including college or day school tuitions. Also, explain how and why this trip will benefit the advancement of your studies.

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**5. Disclaimer and Signature**

By signing below, you are stating that the information outlined above is accurate, and that the amount of scholarship funds you are requesting is necessary in order for the applicant to be able to attend the *2018 Off-Campus Spring Break to Hong Kong*. In order to receive scholarship awards, participants must successfully complete the program, which means participants must attend, and complete the program without any disciplinary problems. Should the participant be sent home for disciplinary problems, the participant must reimburse A+D for the amount of the scholarship award.

Student Signature:		Date:	
Parent Signature:		Date:	

**6. For office use only**

Date received:		Received by:	Henri T. de Hahn	Scholarship award:	\$1,000
Reviewed by:	Kathryn Albright	Approved by:	Kathryn Albright Henri T. de Hahn	Need/Merit:	Need <input type="checkbox"/> Merit <input type="checkbox"/>